

HM628511H Series

4M High Speed SRAM (512-kword × 8-bit)

HITACHI

ADE-203-762D (Z)

Rev. 1.0

Sep. 15, 1998

Description

The HM628511H Series is a 4-Mbit high speed static RAM organized 512-k word × 8-bit. It has realized high speed access time by employing CMOS process (4-transistor + 2-poly resistor memory cell) and high speed circuit designing technology. It is most appropriate for the application which requires high speed, high density memory and wide bit width configuration, such as cache and buffer memory in system. It is packaged in 400-mil 36-pin plastic SOJ.

Features

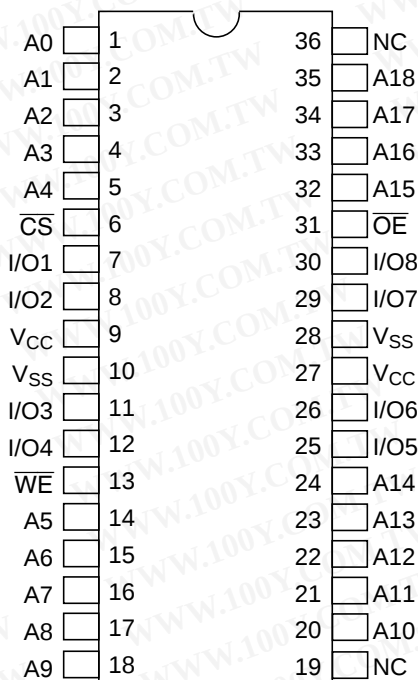
- Single 5.0 V supply : 5.0 V ± 10 %
- Access time 10 / 12 / 15 ns (max)
- Completely static memory
 - No clock or timing strobe required
- Equal access and cycle times
- Directly TTL compatible
 - All inputs and outputs
- Operating current : 180 / 160 / 140 mA (max)
- TTL standby current : 70 / 60 / 50 mA (max)
- CMOS standby current : 5 mA (max)
 - : 1.2 mA (max) (L-version)
- Data retention current: 0.8 mA (max) (L-version)
- Data retention voltage: 2 V (min) (L-version)
- Center V_{CC} and V_{SS} type pinout

勝特力材料 886-3-5753170
勝特力电子(上海) 86-21-54151736
勝特力电子(深圳) 86-755-83298787
[Http://www.100y.com.tw](http://www.100y.com.tw)

勝特力材料 886-3-5753170
勝特力電子(上海) 86-21-54151736
勝特力電子(深圳) 86-755-83298787
[Http://www.100y.com.tw](http://www.100y.com.tw)

Type No.	Access time	Package
HM628511HJP-10	10 ns	400-mil 36-pin plastic SOJ (CP-36D)
HM628511HJP-12	12 ns	
HM628511HJP-15	15 ns	
HM628511HLJ-10	10 ns	
HM628511HLJ-12	12 ns	
HM628511HLJ-15	15 ns	

HM628511HJP/HLJP Series



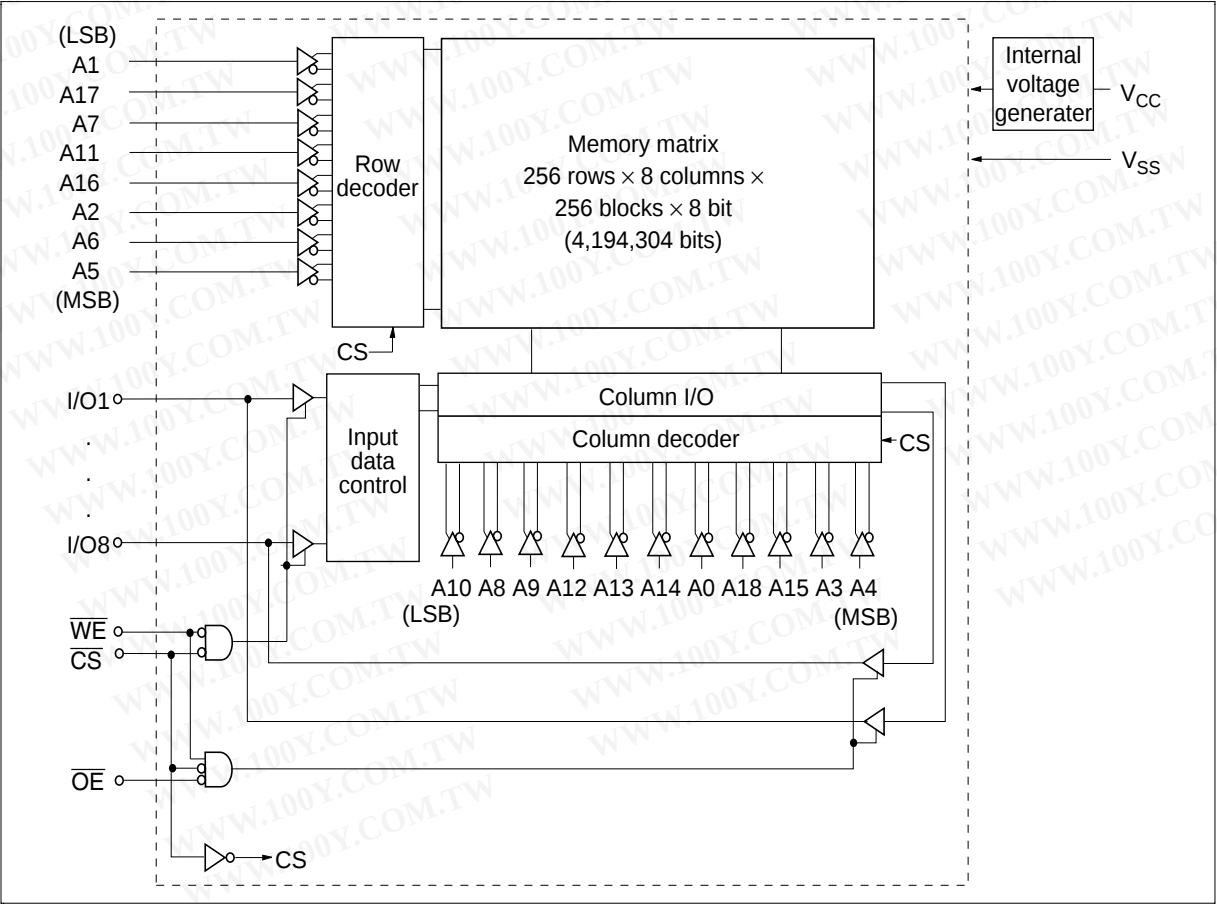
(Top View)

Pin Description

Pin name	Function
A0 to A18	Address input
I/O1 to I/O8	Data input/output
CS	Chip select
OE	Output enable
WE	Write enable
V _{cc}	Power supply
V _{ss}	Ground
NC	No connection

勝特力材料 886-3-5753170
勝特力电子(上海) 86-21-54151736
勝特力电子(深圳) 86-755-83298787
[Http://www.100y.com.tw](http://www.100y.com.tw)

Block Diagram



Operation Table

CS	OE	WE	Mode	V _{CC} current	I/O	Ref. cycle
H	×	×	Standby	I _{SB} , I _{SB1}	High-Z	—
L	H	H	Output disable	I _{CC}	High-Z	—
L	L	H	Read	I _{CC}	Dout	Read cycle (1) to (3)
L	H	L	Write	I _{CC}	Din	Write cycle (1)
L	L	L	Write	I _{CC}	Din	Write cycle (2)

Note: ×: H or L

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Supply voltage relative to V _{SS}	V _{CC}	−0.5 to +7.0	V
Voltage on any pin relative to V _{SS}	V _T	−0.5* ¹ to V _{CC} +0.5* ²	V
Power dissipation	P _T	1.0	W
Operating temperature	T _{opr}	0 to +70	°C
Storage temperature	T _{stg}	−55 to +125	°C
Storage temperature under bias	T _{bias}	−10 to +85	°C

Notes: 1. V_T (min) = −2.0 V for pulse width (under shoot) ≤ 8 ns

2. V_T (max) = V_{CC}+2.0 V for pulse width (over shoot) ≤ 8 ns

Recommended DC Operating Conditions (Ta = 0 to +70°C)

Parameter	Symbol	Min	Typ	Max	Unit
Supply voltage	V _{CC} * ³	4.5	5.0	5.5	V
	V _{SS} * ⁴	0	0	0	V
Input voltage	V _{IH}	2.2	—	V _{CC} + 0.5* ²	V
	V _{IL}	−0.5* ¹	—	0.8	V

Notes: 1. V_{IL} (min) = −2.0 V for pulse width (under shoot) ≤ 8 ns

2. V_{IH} (max) = V_{CC}+2.0 V for pulse width (over shoot) ≤ 8 ns

3. The supply voltage with all V_{CC} pins must be on the same level.

4. The supply voltage with all V_{SS} pins must be on the same level.

DC Characteristics ($T_a = 0$ to $+70^\circ\text{C}$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0\text{V}$)

Parameter	Symbol	Min	Typ* ¹	Max	Unit	Test conditions
Input leakage current	I_{LI}	—	—	2	μA	$V_{in} = V_{SS}$ to V_{CC}
Output leakage current	I_{LO}	—	—	2	μA	$V_{in} = V_{SS}$ to V_{CC}
Operation power supply current	10 ns cycle I_{CC}	—	—	180	mA	Min cycle $\overline{CS} = V_{IL}$, $I_{out} = 0\text{ mA}$ Other inputs = V_{IH}/V_{IL}
	12 ns cycle I_{CC}	—	—	160		
	15 ns cycle I_{CC}	—	—	140		
Standby power supply current	10 ns cycle I_{SB}	—	—	70	mA	Min cycle, $\overline{CS} = V_{IH}$, Other inputs = V_{IH}/V_{IL}
	12 ns cycle I_{SB}	—	—	60		
	15 ns cycle I_{SB}	—	—	50		
	I_{SB1}	—	0.1	5	mA	$f = 0\text{ MHz}$ $V_{CC} \geq \overline{CS} \geq V_{CC} - 0.2\text{ V}$, (1) $0\text{ V} \leq V_{in} \leq 0.2\text{ V}$ or (2) $V_{CC} \geq V_{in} \geq V_{CC} - 0.2\text{ V}$
		—* ²	0.1* ²	1.2* ²		
Output voltage	V_{OL}	—	—	0.4	V	$I_{OL} = 8\text{ mA}$
	V_{OH}	2.4	—	—	V	$I_{OH} = -4\text{ mA}$

Notes: 1. Typical values are at $V_{CC} = 5.0\text{ V}$, $T_a = +25^\circ\text{C}$ and not guaranteed.

2. This characteristics is guaranteed only for L-version.

Capacitance ($T_a = +25^\circ\text{C}$, $f = 1.0\text{ MHz}$)

Parameter	Symbol	Min	Typ	Max	Unit	Test conditions
Input capacitance* ¹	C_{in}	—	—	6	pF	$V_{in} = 0\text{ V}$
Input/output capacitance* ¹	C_{IO}	—	—	8	pF	$V_{IO} = 0\text{ V}$

Note: 1. This parameter is sampled and not 100% tested.

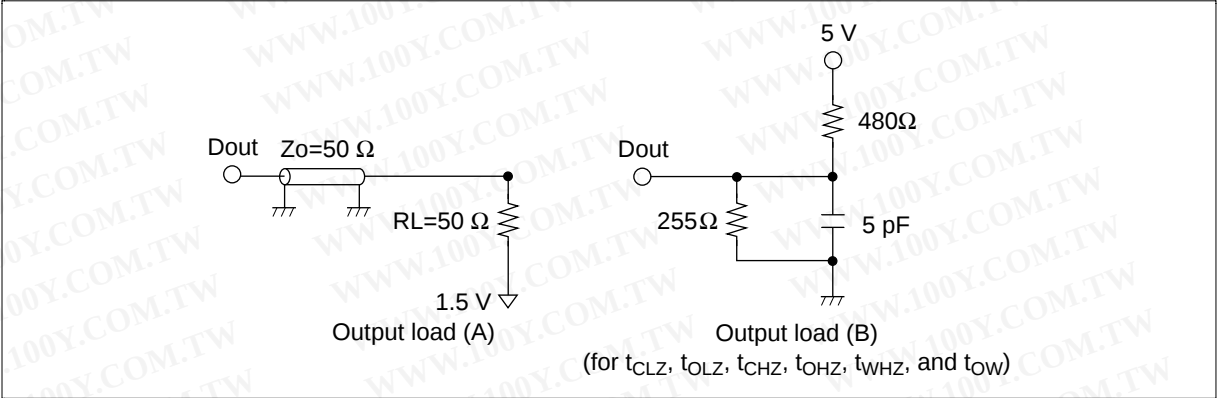
勝特力材料 886-3-5753170
 胜特力电子(上海) 86-21-54151736
 胜特力电子(深圳) 86-755-83298787
[Http://www.100y.com.tw](http://www.100y.com.tw)

AC Characteristics (Ta = 0 to +70°C, VCC = 5.0 V ± 10 %, unless otherwise noted.)

Test Conditions

- Input pulse levels: 3.0 V/0.0 V
- Input rise and fall time: 3 ns
- Input and output timing reference levels: 1.5 V
- Output load: See figures (Including scope and jig)

勝特力材料 886-3-5753170
勝特力电子(上海) 86-21-54151736
勝特力电子(深圳) 86-755-83298787
[Http://www.100y.com.tw](http://www.100y.com.tw)



Read Cycle

HM628511H

Parameter	Symbol	-10		-12		-15		Unit	Notes
		Min	Max	Min	Max	Min	Max		
Read cycle time	t_{RC}	10	—	12	—	15	—	ns	
Address access time	t_{AA}	—	10	—	12	—	15	ns	
Chip select access time	t_{ACS}	—	10	—	12	—	15	ns	
Output enable to output valid	t_{OE}	—	5	—	6	—	7	ns	
Output hold from address change	t_{OH}	3	—	3	—	3	—	ns	
Chip select to output in low-Z	t_{CLZ}	3	—	3	—	3	—	ns	1
Output enable to output in low-Z	t_{OLZ}	0	—	0	—	0	—	ns	1
Chip deselect to output in high-Z	t_{CHZ}	—	5	—	6	—	7	ns	1
Output disable to output in high-Z	t_{OHZ}	—	5	—	6	—	7	ns	1

Write Cycle

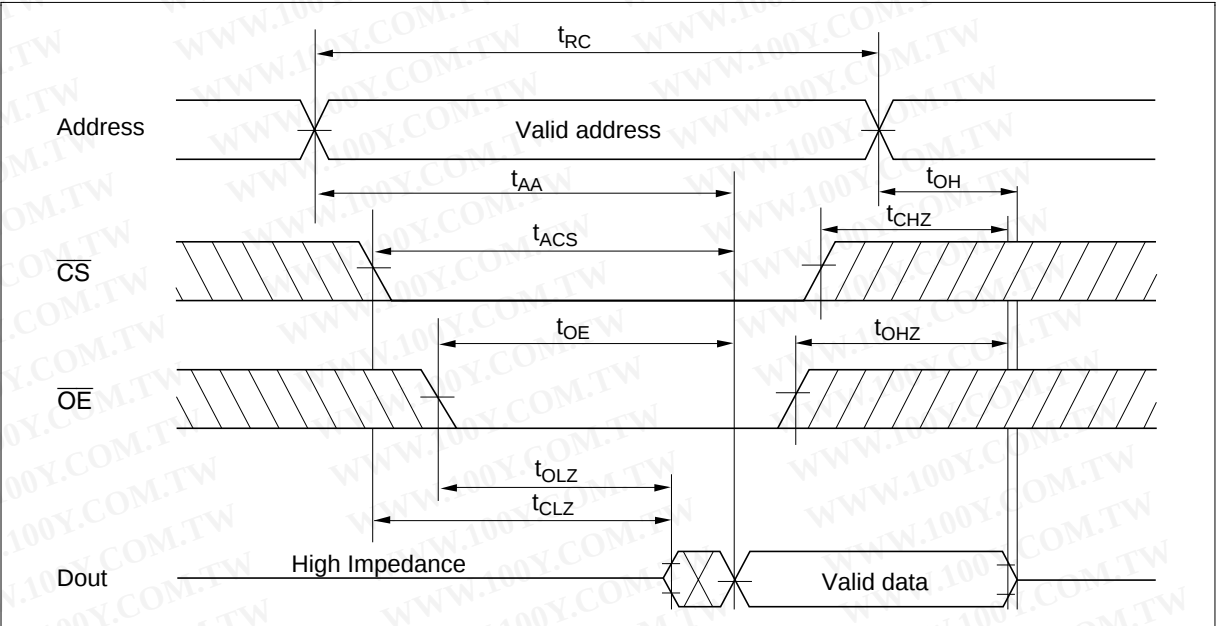
HM628511H

Parameter	Symbol	-10		-12		-15		Unit	Notes
		Min	Max	Min	Max	Min	Max		
Write cycle time	t_{WC}	10	—	12	—	15	—	ns	
Address valid to end of write	t_{AW}	7	—	8	—	10	—	ns	
Chip select to end of write	t_{CW}	7	—	8	—	10	—	ns	9
Write pulse width	t_{WP}	7	—	8	—	10	—	ns	8
Address setup time	t_{AS}	0	—	0	—	0	—	ns	6
Write recovery time	t_{WR}	0	—	0	—	0	—	ns	7
Data to write time overlap	t_{DW}	5	—	6	—	7	—	ns	
Data hold from write time	t_{DH}	0	—	0	—	0	—	ns	
Write disable to output in low-Z	t_{OW}	3	—	3	—	3	—	ns	1
Output disable to output in high-Z	t_{OHZ}	—	5	—	6	—	7	ns	1
Write enable to output in high-Z	t_{WHZ}	—	5	—	6	—	7	ns	1

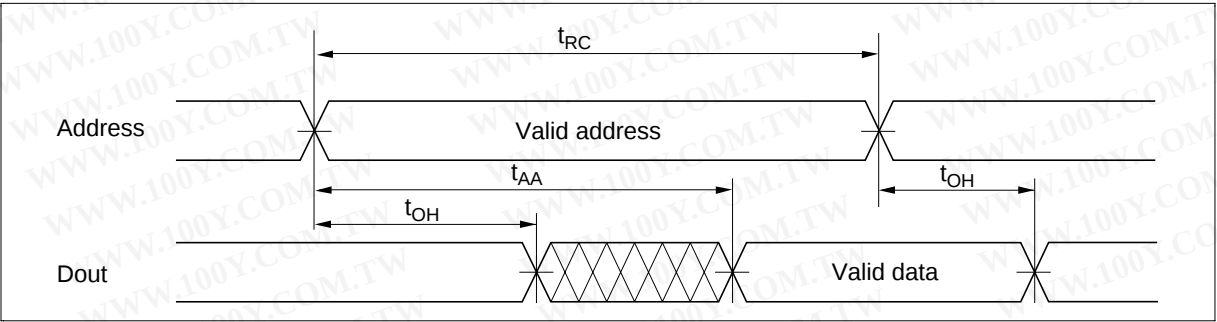
- Note:
1. Transition is measured ± 200 mV from steady voltage with Load (B). This parameter is sampled and not 100% tested.
 2. Address should be valid prior to or coincident with $\overline{CS}$ transition low.
 3. $\overline{WE}$ and/or $\overline{CS}$ must be high during address transition time.
 4. If $\overline{CS}$ and $\overline{OE}$ are low during this period, I/O pins are in the output state. Then, the data input signals of opposite phase to the outputs must not be applied to them.
 5. If the $\overline{CS}$ low transition occurs simultaneously with the $\overline{WE}$ low transition or after the $\overline{WE}$ transition, output remains a high impedance state.
 6. t_{AS} is measured from the latest address transition to the later of $\overline{CS}$ or $\overline{WE}$ going low.
 7. t_{WR} is measured from the earlier of $\overline{CS}$ or $\overline{WE}$ going high to the first address transition.
 8. A write occurs during the overlap of a low $\overline{CS}$ and a low $\overline{WE}$. A write begins at the latest transition among $\overline{CS}$ going low and $\overline{WE}$ going low. A write ends at the earliest transition among $\overline{CS}$ going high and $\overline{WE}$ going high. t_{WP} is measured from the beginning of write to the end of write.
 9. t_{CW} is measured from the later of $\overline{CS}$ going low to the the end of write.

Timing Waveforms

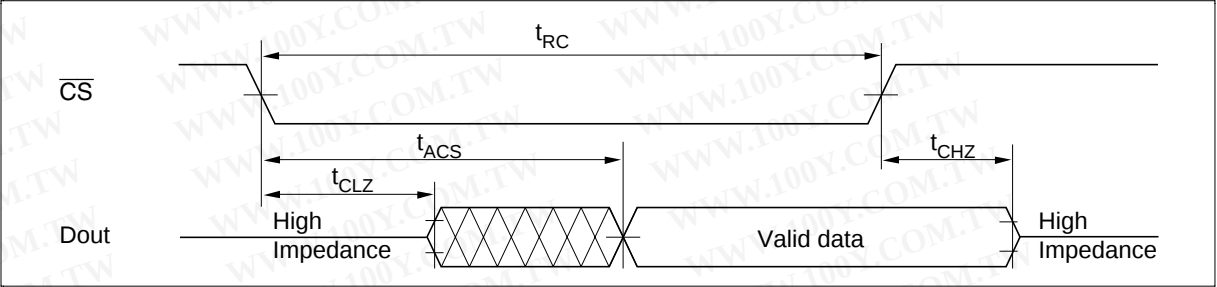
Read Timing Waveform (1) ($\overline{WE} = V_{IH}$)



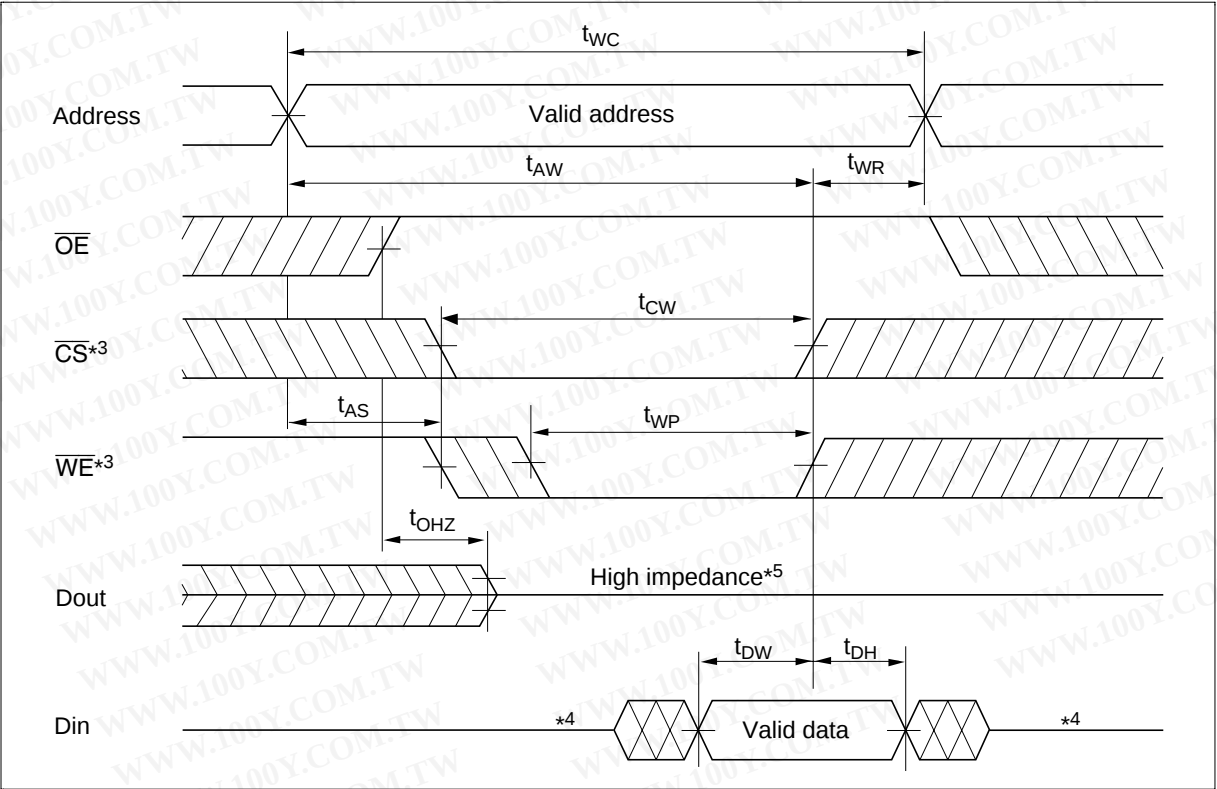
Read Timing Waveform (2) ($\overline{WE} = V_{IH}$, $\overline{CS} = V_{IL}$, $\overline{OE} = V_{IL}$)



Read Timing Waveform (3) ($\overline{WE} = V_{IH}$, $\overline{CS} = V_{IL}$, $\overline{OE} = V_{IL}$)*2

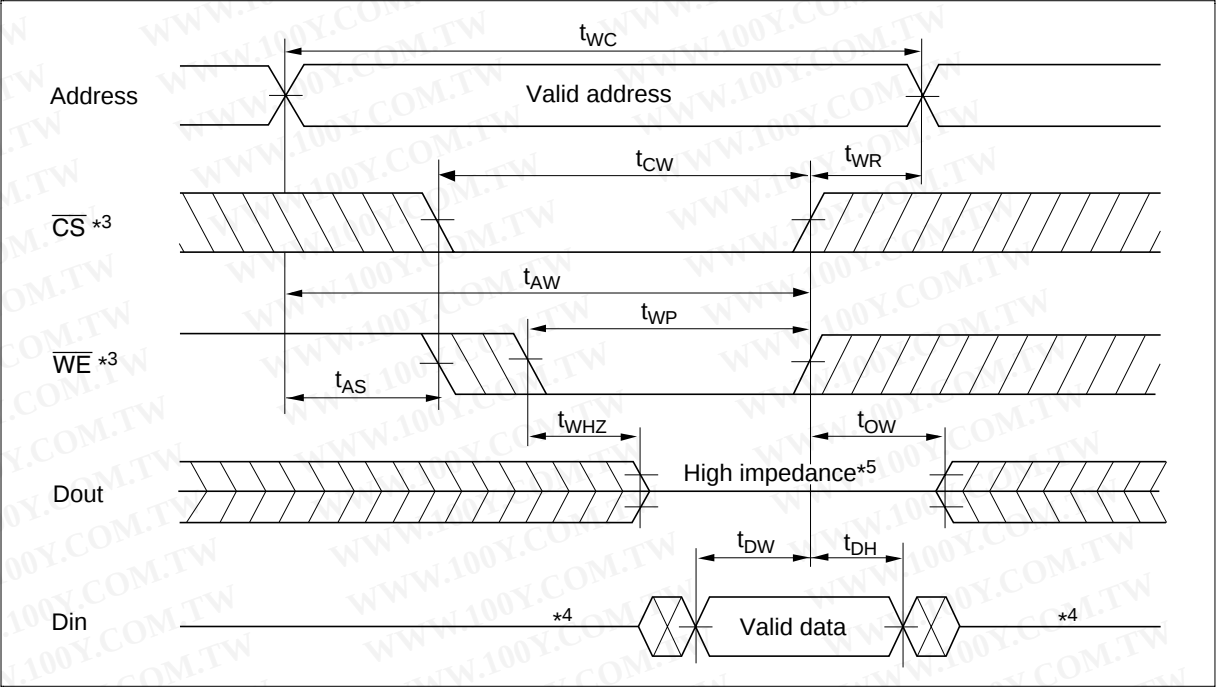


Write Timing Waveform (1) ($\overline{WE}$ Controlled)



勝特力材料 886-3-5753170
勝特力电子(上海) 86-21-54151736
勝特力电子(深圳) 86-755-83298787
[Http://www.100y.com.tw](http://www.100y.com.tw)

Write Timing Waveform (2) ($\overline{\text{CS}}$ Controlled)



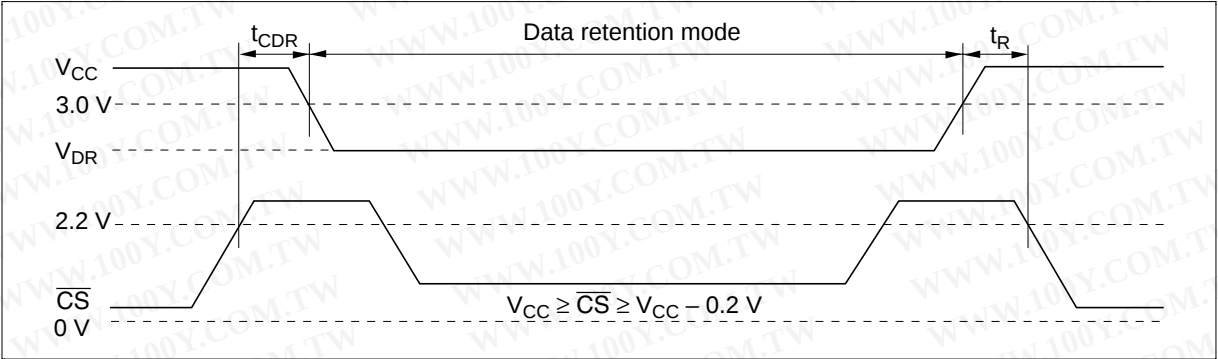
Low V_{CC} Data Retention Characteristics (Ta = 0 to +70°C)

This characteristics is guaranteed only for L-version.

Parameter	Symbol	Min	Typ*1	Max	Unit	Test conditions
V _{CC} for data retention	V _{DR}	2.0	—	—	V	V _{CC} ≥ $\overline{CS}$ ≥ V _{CC} − 0.2 V (1) 0 V ≤ Vin ≤ 0.2 V or (2) V _{CC} ≥ Vin ≥ V _{CC} − 0.2 V
Data retention current	I _{CCDR}	—	50	800	μA	V _{CC} = 3 V, V _{CC} ≥ $\overline{CS}$ ≥ V _{CC} − 0.2 V (1) 0 V ≤ Vin ≤ 0.2 V or (2) V _{CC} ≥ Vin ≥ V _{CC} − 0.2 V
Chip deselect to data retention time	t _{CDR}	0	—	—	ns	See retention waveform
Operation recovery time	t _R	5	—	—	ms	

Note: 1. Typical values are at V_{CC} = 3.0 V, Ta = +25°C, and not guaranteed.

Low V_{CC} Data Retention Timing Waveform



勝 特 力 材 料 886-3-5753170
胜特力电子(上海) 86-21-54151736
胜特力电子(深圳) 86-755-83298787
[Http://www.100y.com.tw](http://www.100y.com.tw)

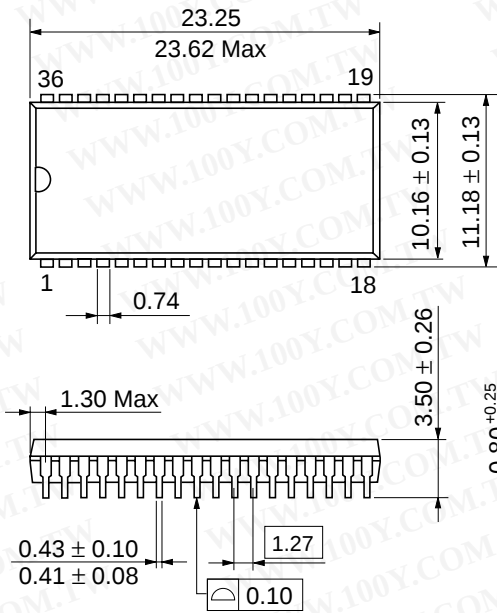
HM628511H Series

勝 特 力 材 料 886-3-5753170
勝特力电子(上海) 86-21-54151736
勝特力电子(深圳) 86-755-83298787
[Http://www.100y.com.tw](http://www.100y.com.tw)

Package Dimensions

HM628511HJP/HLJP Series (CP-36D)

Unit: mm



Hitachi Code	CP-36D
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	1.4 g

Dimension including the plating thickness
Base material dimension